

Wurth 744772470 alternative



ITEM	DR CHOKE, 47uH+-10%
Part Number	GDR0807CQ1-470KU-L5
ELECTRICAL	INDUCTANCE: 47uH±10%
REQUIREMENTS	DCR: 0.16Ω MAX.
	Isat current: 2.55A MAX
	Irms current: 1.8A (△T=40°C typ.)
	SRF: 9.2MHz TYP.

TEST METHOD:

TEST EQUIPMENT	CH3302 / CH1320
TEST FREQUENCY	100kHz, 0.25V

DIMENSION : (UNIT:mm)





RELIABILITY TEST



- 1. Operating temperature range
 - -40 TO + 125° (Includes temperature when the coil is heated)
- 2. High temperature exposure(storage) refer MIL-STD-202 Method 108:
 - 1000 hrs at rated operating temperature(e.g. 125°). Part can be stored for 1000 hrs @ 125° . Unpowered. Measurement at 24±4 hours after test conclusion.
- 3. Temperature cycling refer JESD22 Method JA-104: 1000 cycles(-40 TO + 125℃). Measurement at 24±4 hours after test conclusion.
 30 min maximum dwell time at each temp. extreme. 1 min. maximum transition time.
- Biased Humidity refer MIL-STD-202 Method 103: 1000 hours 85°C/85%RH. Unpowered. Measurement at 24±4 hours after test conclusion.
- 5. Operational Life refer MIL-PRF-27: 1000 hrs. at 125 °C tested. Measurement at 24±4 hours after test conclusion.
- 6. External Visual refer MIL-STD-883 Method 2009: Inspect device construction, marking and workmanship.
- 7. Physical Dimension refer JESD22 Method JB-100:

Verify physical dimensions to the applicable device detail specification.

- Resistance to Solvents refer MIL-STD-202 Method 215:
 Add aqueous wash chemical OKEM clean or equivalent.
- 9. Mechanical Shock refer MIL-STD-202 Method 213: Figure 1 of Method 213. Condition C.
- 10. Vibration refer MIL-STD-202 Method 204: 5g's for 20 minutes, 12 cycles each of 3 orientations. Test from 10-2000 Hz.
- Resistance to soldering Heat refer MIL-STD-202 Method 210: Condition B No pre-heat of samples. Single wave solder-procedure 2 for SMD and procedure 1 for leaded with solder within 1.5mm of device body.
- 12. ESD refer AEC-Q200-002 or ISO/DIS 10605: Direct contact discharge 2kV.
- 13. Solderability refer J-STD-002: For both Leaded & SMD. Magnification 50X. Conditions: Leaded, Method A@235℃,category 3 ;
- Electrical Characterization refer spec: Show Min, Max Mean and Standard deviation at room from Min and Max temperature.
- 15. Flammability refer UL-94: V-0 or V-1 Acceptable.
- 16. Board Flex refer AEC-Q200-005: 60 sec minimum holding time.
- 17. Terminal Strength(Leaded) refer MIL-STD-202 Method 211(SDM): Test leaded device lead integrity only. Conditions: A(910g), C(1.13kg), E(1.45kg-mm)
- 18. Storage environment
 Storage condition: Temperature Range: 0°C ~ 35°C ; -40°C ~ 125°C (after PCB)
 Humidity Range: 50% ~ 70% RH

Use components within 12 months. If 12 months or more have elapsed, check solderability before use.

	APPROVED		CHECKE	CORREC	T DE	DESIGNED	
FORM NO: QPTE01-F0101							
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